MBD101, MMBD101LT1

Preferred Device

Schottky Barrier Diodes

Designed primarily for UHF mixer applications but suitable also for use in detector and ultra-fast switching circuits. Supplied in an inexpensive plastic package for low-cost, high-volume consumer requirements. Also available in Surface Mount package.

Features

- Low Noise Figure 6.0 dB Typ @ 1.0 GHz
- Very Low Capacitance Less Than 1.0 pF
- High Forward Conductance -0.5 V (Typ) @ I_F = 10 mA
- Pb–Free Packages are Available

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	7.0	V
$\begin{tabular}{lllllllllllllllllllllllllllllllllll$	P _F	280 225 2.2 1.8	mW mW/°C
Junction Temperature	TJ	+150	°C
Storage Temperature Range	T _{stg}	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

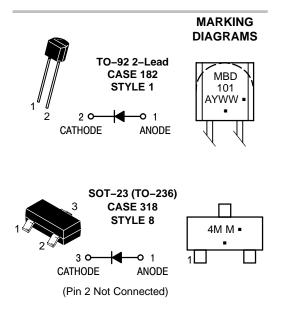
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage $(I_R = 10 \ \mu A)$	V _{(BR)R}	7.0	10	-	V
Diode Capacitance (V _R = 0, f = 1.0 MHz, Note 1, page 2)	CD	-	0.88	1.0	pF
Forward Voltage (I _F = 10 mA)	V _F	-	0.5	0.6	V
Reverse Leakage (V _R = 3.0 V)	I _R	-	0.02	0.25	μΑ



ON Semiconductor®

http://onsemi.com

SILICON SCHOTTKY BARRIER DIODES





- Y = Year
- WW = Work Week
- 4M = Device Code (SOT-23)
- M = Date Code*
- = Pb–Free Package

(Note: Microdot may be in either location) *Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBD101	TO-92	5000 Units / Box
MBD101G	TO-92 (Pb-Free)	5000 Units / Box
MMBD101LT1	SOT-23	3000 / Tape & Reel
MMBD101LT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

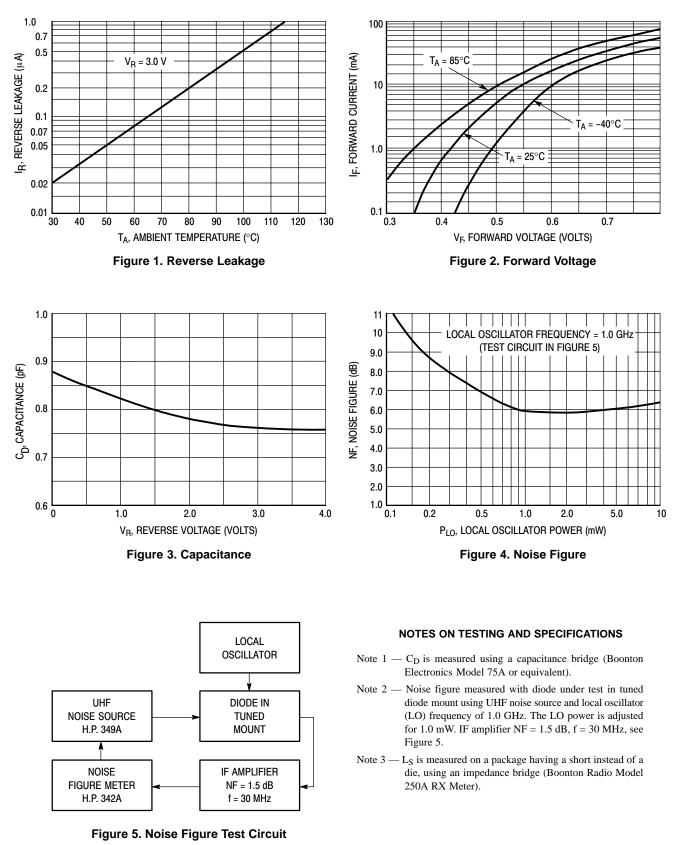
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

MBD101, MMBD101LT1

TYPICAL CHARACTERISTICS

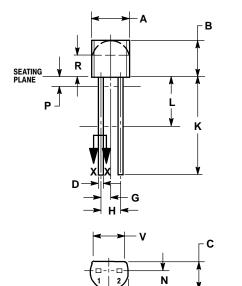
 $(T_A = 25^{\circ}C \text{ unless noted})$



PACKAGE DIMENSIONS

TO-92 TWO LEAD TO-226AC

CASE 182-06 **ISSUE L**



Ν

Å



SECTION X-X

NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND ZONE R IS UNCONTROLLED. 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

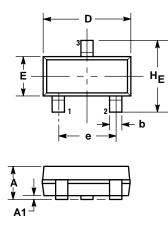
	INCHES		MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.175	0.205	4.45	5.21	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.050 BSC		1.27 BSC		
Н	0.100 BSC		2.54 BSC		
J	0.014	0.016	0.36	0.41	
Κ	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.03	2.66	
Ρ		0.050		1.27	
R	0.115		2.93		
٧	0.135		3.43		

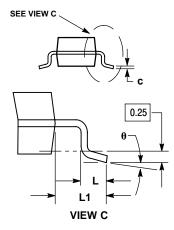
STYLE 1: PIN 1. ANODE 2. CATHODE

MBD101, MMBD101LT1

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**





NOTES:

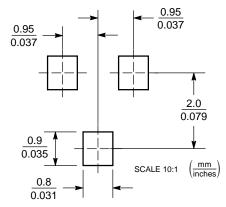
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14 5M 1982
- CONTROLLING DIMENSION: INCH. 2. 3
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL
- 318-01 THRU -07 AND -09 OBSOLETE, NEW 4 STANDARD 318-08.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
ΗE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 8:

3. CATHODE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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